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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon PNP Triple Diffused

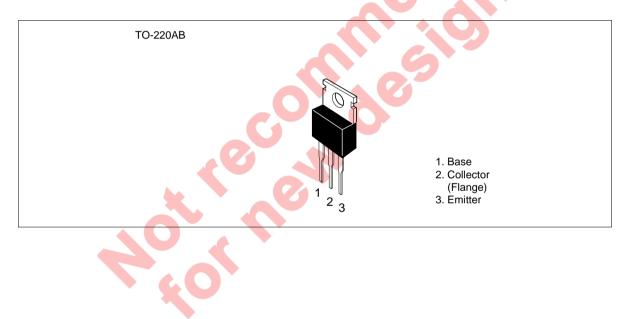


ADE-208-855 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier power switching complementary pair with 2SD476(K) and 2SD476A(K)

Outline



Absolute Maximum Ratings (Ta = 25° C)

		Ratings			
Item	Symbol	2SB566(K)	2SB566A(K)	Unit	
Collector to base voltage	V _{CBO}	-70	-70	V	
Collector to emitter voltage	V _{CEO}	-50	-60	V	
Emitter to base voltage	V _{EBO}	-5	5	V	
Collector current	I _c	-4	-4	А	
Collector peak current	C(peak)	-8	-8	А	
Collector power dissipation	Pc*1	40	40	W	
Junction temperature	Tj	150	150	°C	
Storage temperature	Tstg	-55 to +150	-55 to +150	°C	

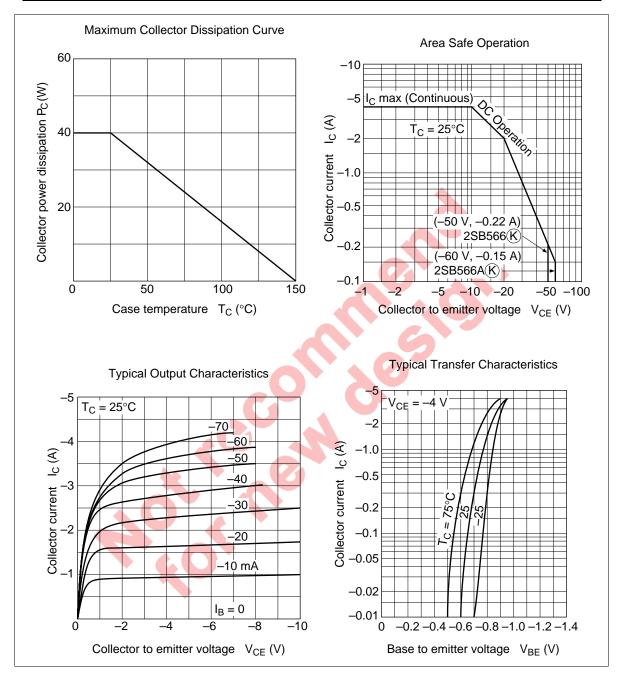
Electrical Characteristics (Ta = 25°C)

otorage temperature			Totg				00	00 1	0		
Note: 1. Value at T_c =	= 25°C.					~		0	C		
Electrical Characteristics (Ta = 25°C)											
		2SB566(K) 2SB566A(K)		Z							
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions		
Collector to base breakdown voltage	$V_{(BR)CBO}$	-70	C		-70	-	—	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$		
Collector to emitter breakdown voltage	V _{(BR)CEO}	-50	—	1	-60	—	—	V	$I_{\rm c}$ = –50 mA, R _{BE} = ∞		
Emitter to base breakdown voltage	V _{(BR)EBO}	-5	~	3	-5	—	—	V	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$		
Collector cutoff current	I _{CBO}	-	F .	-1		_	-1	μΑ	$V_{_{CB}} = -50 \text{ V}, \text{ I}_{_{E}} = 0$		
DC current tarnsfer ratio	h _{FE1} *1	60	_	200	60	_	200	_	$V_{ce} = -4 V$, $I_c = -1 A$		
	h _{FE2}	35		_	35	_			$V_{ce} = -4 V$, $I_c = -0.1 A$		
Collector to emitter saturation voltage	V _{CE(sat)}	_	—	-1.0	—	—	-1.0	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -0.2$ A		
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	—	—	-1.2	—	—	-1.2	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -0.2$ A		
Gain bandwidth product	f _T	_	15	_	_	15		MHz	$V_{\rm CE}$ = -4 V, I _c = -0.5 A		
Turn on time	t _{on}		0.3	_	_	0.3		μs	V _{cc} = -10.5 V		
Turn off time	t _{off}	_	3.0	_	_	3.0		μs	$I_{\rm C} = 10I_{\rm B1} = -10I_{\rm B2} =$		
Storage time	t _{stg}	_	2.5	—	—	2.5	—	μs	–0.5 A		

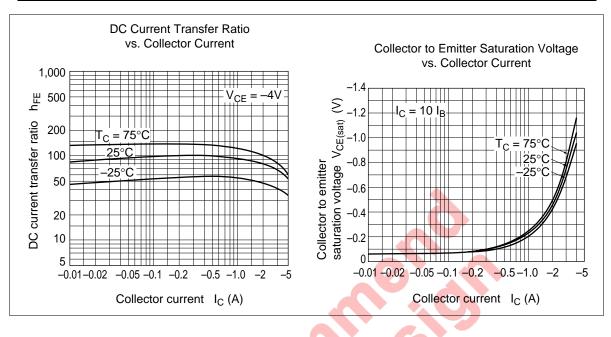
Note: 1. The 2SB566(K) and 2SB566A(K) are grouped by $h_{\mbox{\tiny FE1}}$ as follows.

С в

60 to 120 100 to 200



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